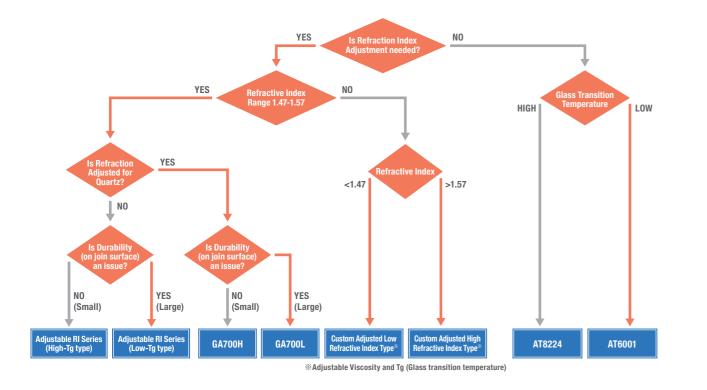
Flow Chart: Selecting Optical Waveguide Adhesives Based On Application Usage



Measurement Item and Method of Measurement used for this Catalog

Measurement Item		Method of Measurement	Measurement Item	Method of Measurement		
Uv curing	Light source	Metal halide lamp (Center wavelength 365 nm)	Optical transmittance	UV Spectrophotometer (Sample thickness 1mm)		
condition	Heat-treating	Conditions as described in the Instruction manual	Hardness (Shore d, a)	Hardness meter		
Refractive	index	Abbe refractometer (at 25°C)	Thermal expansion coefficient	TMA (Thermomechanical analysis)		
Viscosity		E-type viscometer (at 25°C)	Shrinkage during curing	Calculated from the difference in density before and after curing		
Glass trans	sition temperature	Maximum peak temperature of viscoelastic spectrum $ an \delta$	Water vapor transmission rate	Transmittance measuring instrument (Sample thickness 0.5mm)		
			Pot life	Time for confirmation of fluid flow to ø3mm SUS tube		

Feel free to contact us if you have any questions about adhesives, requirements of custom adhesives, and measurement and testing services for adhesives.

Measurement and Testing Services for Adhesives

The Optical characteristics	Refractive index, Optical transmittance, Absorbance	The Thermal characteristics	Thermal expansion coefficient, Thermogravimetric analysis	
The Electrical characteristics	Permittivity, Resistivity	The Material characteristics	Viscosity, Density, Shrinkage during curing etc.	
The Mechanical characteristics	Bond Strength, Viscoelasticity etc.	Various environmental tests	Longevity tests, Durability tests	

Custom Adhesives, Measurement and Testing Services for Adhesives

Notes

All company names, product names, etc., indicated herein are trademarks or registered trademarks of each respective company.
Please understand that all comments and data recorded herein may be subject to change without prior notification.

Catalog descriptions: as of March, 2018

For more information, please contact

http://www.ntt-at.com/product/adhesive/

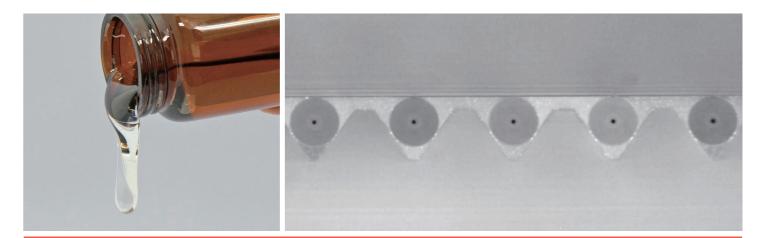


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NTT-AT Optical Adhesives Lineup





Adhesives / Resins and Sealants for Optical Component Assembly

The adhesive technology used in optical communications is one of the key technologies we offer. Ask us anything you need to know Adhesives for optical component assembly.

Adjust the Viscosity

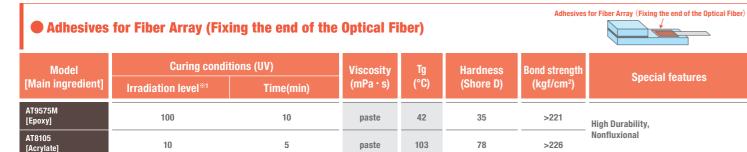
Adjust the Refractive Index

Consultation available for customization of each type. Feel free to contact us if you have any questions.

Adhesives for Optical Waveguides Optical Fiber Adhesives for Optical Waveguides											
Model	Curing conditions (UV)		Refractive index (after hardening)	Viscosity	Tg	Optical transmittance	Bond strength	Special features			
[Main ingredient]	Irradiation level ^{**1}	Time (min)	@589nm	(mPa · s)	(°C)	(%) @1.3µm	(kgf/cm²)	Special leatures			
Adjustable RI Series (High-Tg type) [Epoxy]	30	10	1.458 - 1.567	250 - 2000	140 - 150	89 - 90	120 - 180	Refractive index can be adjusted in accordance with the customer's specification, High-Tg			
Adjustable RI Series (Low-Tg type) [Epoxy]	10	10	1.458 - 1.567	200 - 560	40 - 50	86 - 90	>200	Refractive index can be adjusted in accordance with the customer's specification, Low-Tg			
GA700H (High-Tg type) [Epoxy]	30	10	1.46	280	145	91	>247	Refractive index adjusted to match silica glass (at 1.55µm), High-Tg			
GA700L (Low-Tg type) [Epoxy]	10	5	1.46	250	46	94	>154	Refractive index adjusted to match silica glass (at 1.55µm), Low-Tg			
AT6001 [Acrylate]	10	5	1.51	470	0	91	99	Complies with Telecordia Standards (High Temperature/High Humidity), High Elasticity			
AT8224 [Acrylate]	10	5	1.51	145	115	89	>209	Complies with Telecordia Standards (High Temperature/High Humidity), High-Tg			

Tg: Glass transition temperature

Adhesives for Fiber Array (Fixing Optical Fiber and the V-groove) Adhesives for Fiber Array (Fixing Optical Fiber and the V-groove)											
Model	Curing condit	ions (UV)	Refractive index (after hardening)	Viscosity (mPa•s)	Tg (°C)		Bond strength	Special features			
[Main ingredient]	Irradiation level ^{**1}	Time (min)	@589nm				(kgf/cm²)				
AT3925M [Epoxy]	100	10	1.52	200	219	88	>99	Mechanical polishing is available, Ultra-Hard, Heat-Resistant Adhesive			
AT9390 [Epoxy]	30	10	1.49	600	131	81	>194	Mechanical polishing is available, Good Transparency			
AT9968 [Epoxy]	100	10	1.51	70	181	85	>143	Mechanical polishing is available, Low Viscosity			
AT3727E [Epoxy]	10	10	1.57	400	107	83	>147	Mechanical polishing is available, Humidity-Resistant, High-Tg			
AT3728E [Epoxy]	10	10	1.57	400	55	20	>232	Mechanical polishing is available, Humidity-Resistant, Low-Tg			



Adhesive for Precise Fixation										
Model [Main ingredient]	Curing conditions (UV) Irradiation level ^{#1} Time(min)		Shrinkage during curing (%)	Viscosity (mPa•s)	Tg (°C)	Thermal expansion coefficient (10 ⁻⁵ /°C)		Special features		
AT3862P [Epoxy]	100	2	0.5	180,000	195	2	>210	Low Shrinkage Rate		
AT3916P [Epoxy]	100	2	0.9	36,000	233	2	>220	Low Viscosity		

High RI Resins										
Curing condi	tions (UV)	Refractive index (after hardening)	Viscosity	Tg	Hardness (Chara D)	Bond strength				
Irradiation level ^{**1}	Time (min)	@589nm	(mPa·s)	(*6)	(Shore D)	(kgf/cm²)				
10	5	1.68	9	113	67	>48				
10	10	1.66	360	150	79	>107				
100	5	1.72	20	68	70	35				
100	5	1.60	1,200	73	76	>280				
100	10	1.63	11,000	63	83	55				
	Curing condi Irradiation level*1	Curing contitons (UV)Irradiation level*1Time (min)105101010051005	Curing contitions (UV)Refractive index (after hardening) @589nmIrradiation level ^{**1} Time (min)@589nm1051.6810101.6610051.7210051.60	Curing conditions (UV) Irradiation level**1Refractive index (after hardening) @589nmViscosity (mPa · s)1051.68910101.6636010051.722010051.601,200	Curing conditions (UV) Irradiation level**1Refractive index (after hardening) @589nmViscosity (mPa · s)Tg (°C)1051.68911310101.6636015010051.72206810051.601,20073	Curing conditions (UV) Irradiation level**1Refractive index (after hardening) @589nmViscosity (mPa · s)Tg (°C)Hardness (Shore D)1051.6891136710101.663601507910051.7220687010051.601,2007376				

Low RI Resins

Model	Curing condi	tions (UV)	Refractive index	Viscosity	Tg	Hardness	Bond strength	
[Main ingredient]	Irradiation level ^{*1}	Time (min)	(after hardening) @589nm	(mPa∙s)	(°C)	(Shore D)	(kgf/cm²)	
#18204 [Acrylate]	10	1	1.38	7	18	20	27	
#18114 [Acrylate]	10	5	1.40	25	94	72	26	
E3810 [Epoxy]	10	10	1.44	100	103	78	>61	

Epoxy Resins for Fabricating Optical Waveguide									
Model		Refractive index (after hardening) @830nm	Viscosity (mPa · s)	Tg (°C)	Δn (@830nm)				
Care / Cladding act	Core	1.53 ±0.005	2,200	222	1.3%				
Core / Cladding set	Cladding	1.51 ±0.005	2,900	200	1.3%				

• Seala	Sealants for Optical Devises										
Model	Curing conditions	Pot life (min)	Water vapor transmission Rate ^{%2}	Hardness (Shore D)	Bond strength ^{**3} (kgf/cm²)	Ratio of mixing (Weight A/B)	Main component	Conditions before hardening	Special features		
0\$5958	RT 24hr	120	1.6×10 ⁻⁸ [85℃ 85%]	47	131	10:3		A: White paste B: Yellow transparent fluid	High Moisture Proof Long Pot Life		
O\$5962	or 80°C 1hr	120	0.7×10 ⁻⁸ [85°C 85%]	66	146	21 : 3	A: Epoxy Resin B: Amine Hardener	A: White paste B: Yellow transparent fluid	High Moisture Proof, High Viscosity, Long Pot Life		
OS5980	80°C 1hr	120	3×10 ⁻⁷ [85°C 85%]	20	24	1:2		A: Transparent paste B: Black paste	High Flexibility		
0S-48	RT 24hr or 100°C 1hr	180	1×10 ⁻⁸	66 (Shore A)	11	1:1	A/B: Butylene Resin	A: White paste B: Black paste	Long Pot Life		

1: [mW/cm²] 2: [CC · cm/cmHg · cm² · s]@75°C 90% 3: Shear adhesion strength of SUS / SUS (All other cases are glass / glass) • Data in thie catalog is the measured values, not guaranteed values.